SPECIFICATION

REFOND P/N

RF-A4E27-R15H-S1

□R&D

■Mass Production

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1. Description

1.1

The red source color devices are made with AlGaInP on substrate light emitting diode.

Product package:2.7mmX2.0mmX0.6mm.

LED AlGaInp 2.7mmX2.0mmX0.6mm

1.2Features

EMC Package.EMC

Extremely wide viewing angle.

Suitable for all SMT assembly and solder process. SMT

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1.4Package Dimension

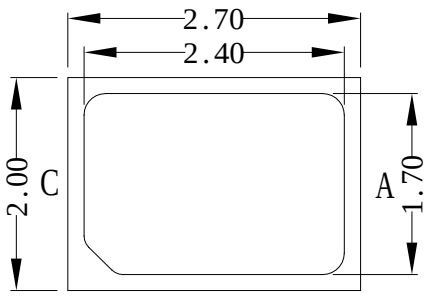

Fig.1-1 Top View

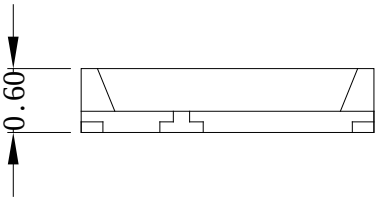

Fig.1-2 Side View

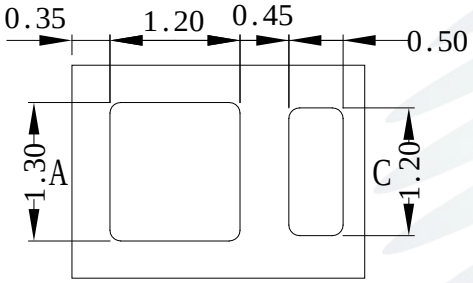

Fig.1-3 Bottom View

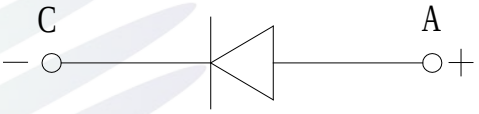

Fig.1-4 Polarity

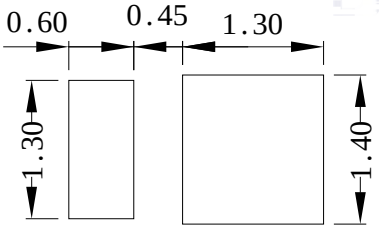

Fig.1-5 Soldering Patterns

Notes

1. All dimensions units are millimeters.
2. All dimensions tolerances are ±0.2mm unless otherwise noted.

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1.5Product Parameters

Table 1-1 Electrical / Optical Characteristics at Ts=25°C

Item	Symbol	Test Condition	Value			Unit
			Min.	Typ.	Max.	
Forward Voltage	V_F	I_F=350mA	2.0	2.3	2.6	V
Reverse Current	I_R	V_R=5V	---	---	10	uA
Luminous Flux		I_F=350mA	55.3	---	93.2	lm
Dominant Wavelength	$_D$	I_F=350mA	612.5	---	625	nm
Viewing Angle		I_F=350mA	---	120	---	deg
Thermal Resistance (Junction to Solder)	Rth JS real	I_F=350mA	---	12	19	/W
	Rth JS el	I_F=350mA	---	6	10	/W

Table 1-2 Absolute Maximum Ratings at Ts=25°C

Parameter	Symbol	Rating	Units
Power Dissipation	P_D	1092	mW
Forward Current	I_F	420	mA
Peak Forward Current	I_{FP}	700	mA
Reverse Voltage	V_R	5	V
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature	T_{OPR}	-40 ~ +125	
Storage Temperature	T_{STG}	-40 ~ +125	
Junction Temperature	T_J	150	

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Notes

1. 1/10 Duty cycle, 10ms pulse width. 10ms, 1/10.

2. The above forward voltage measurement allowance tolerance is ±0.1V. ±0.1V.

3. The above color coordinates measurement allowance tolerance is ±0.005. ± 0.005.

4. The above luminous flux measurement allowance tolerance ±10%. ±10%.

5. Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product.

6. All measurements were made under the standardized environment of Refond.

7.When the LEDs are in operation the maximum current should be decided after measuring the package temperature, junction temperature should not exceed the maximum rate. LED

8. At 25 , pulse mode test, photoelectric conversion efficiency 47%. 25 47%

9.Thermal resistance values (Rth JS Electrical) measure current is 350mA ,Temperature constant at 25 C. (Rth JS Electrical) 350mA 25°C

1.6 Bin Range Of Forward Voltage and Luminous Flux (IF=350mA)

BIN (IF=350mA)

Table 1-3

V_F V	C0	D0	E0		
	2.0-2.2	2.2-2.4	2.4-2.6		
lm	PA	PB	QA	QB	RA
	55.3-61.2	61.2-67.8	67.8-75.3	75.3-83.7	83.7-93.2
WD(nm)	C2	D1	D2	E1	E2
	612.5-615	615-617.5	617.5-620	620-622.5	622.5-625

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1.7 Typical Optical Characteristics Curves

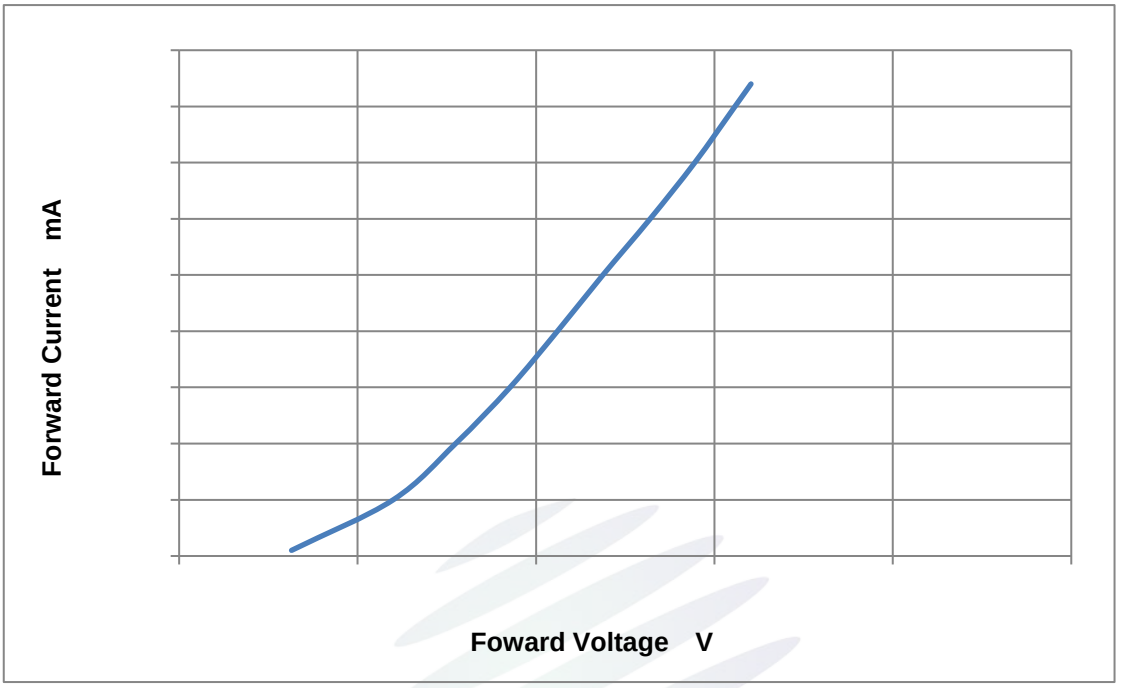

Fig. 1-6 Forward Voltage Vs Forward Current

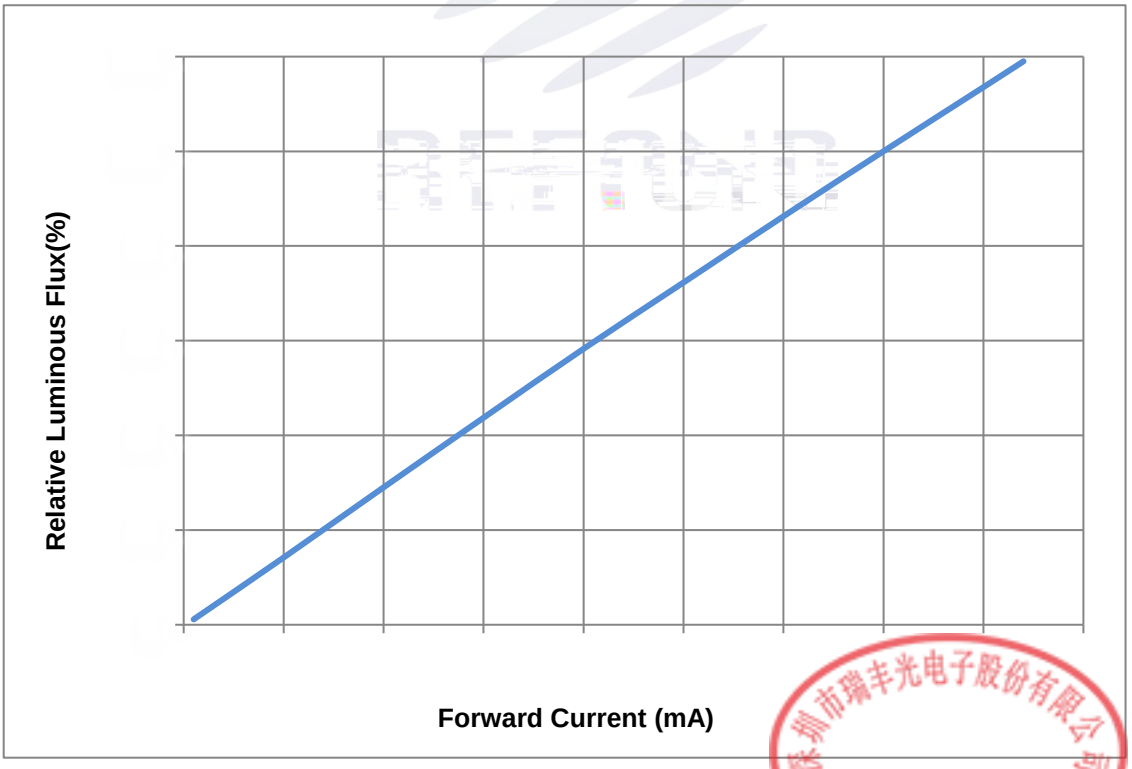

Fig. 1-7 Forward Current Vs Relative Luminous Flux

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Fig. 1-8 Junction Temperature Vs Relative Luminous Flux

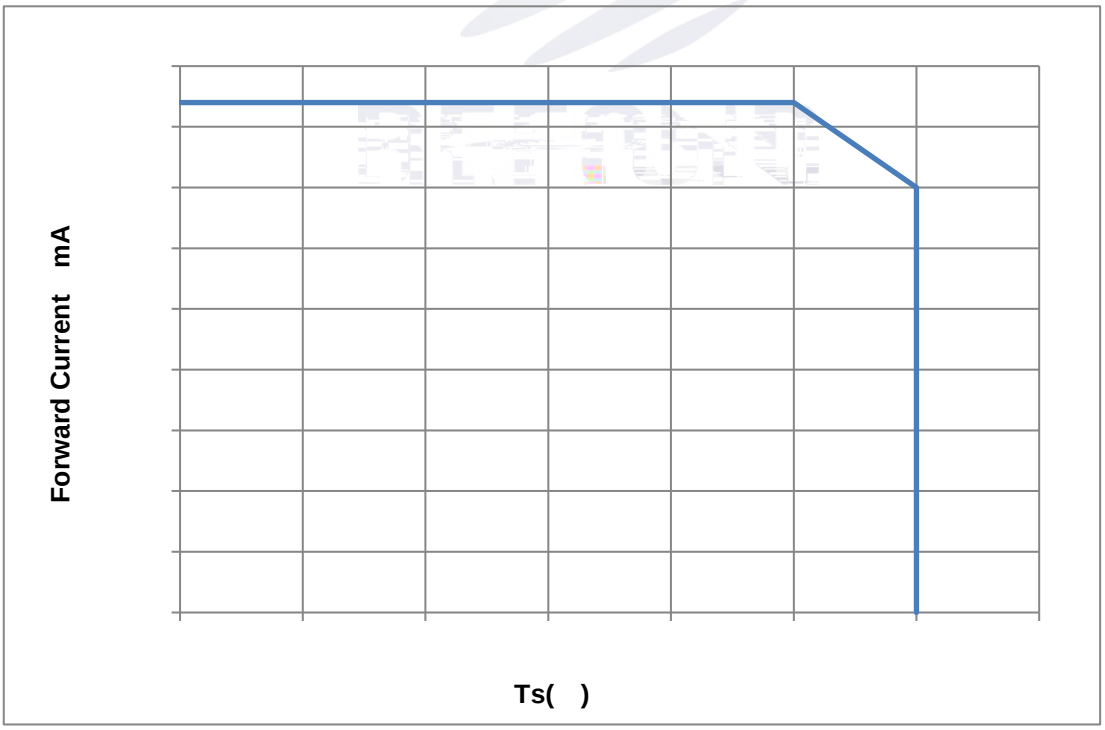

Fig. 1-9 Solder Temperature Vs Forward Current

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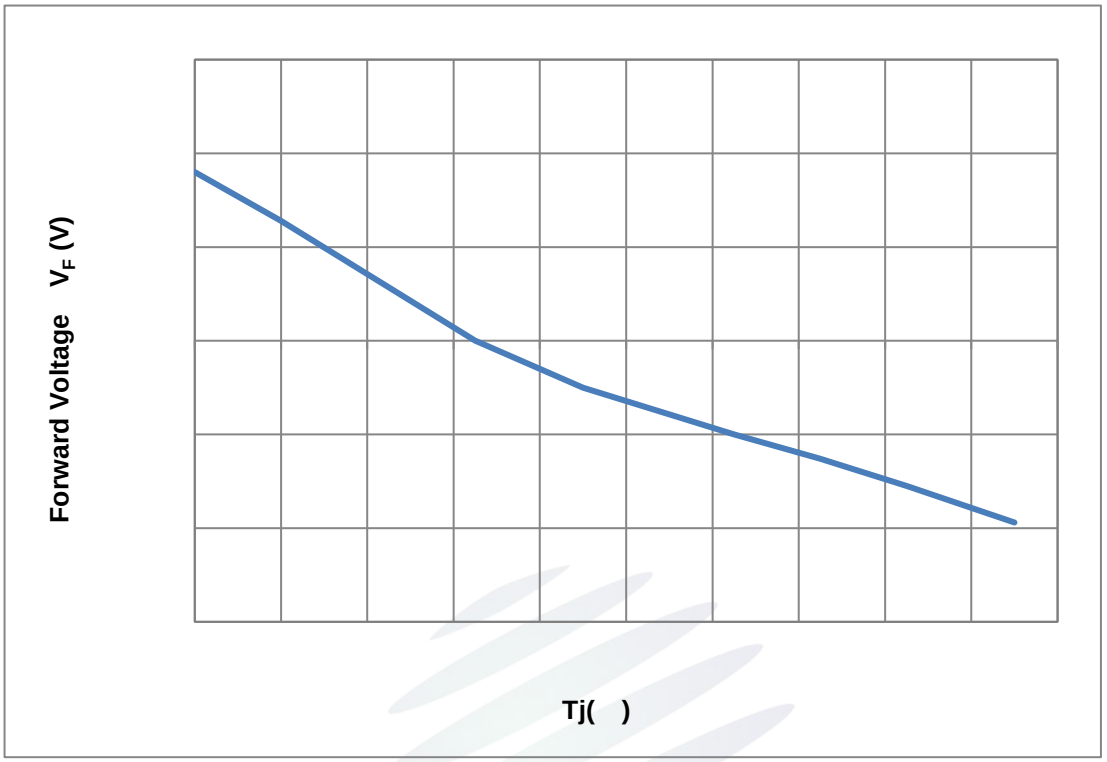

Fig. 1-10 Voltage Shift Vs Junction Temperature

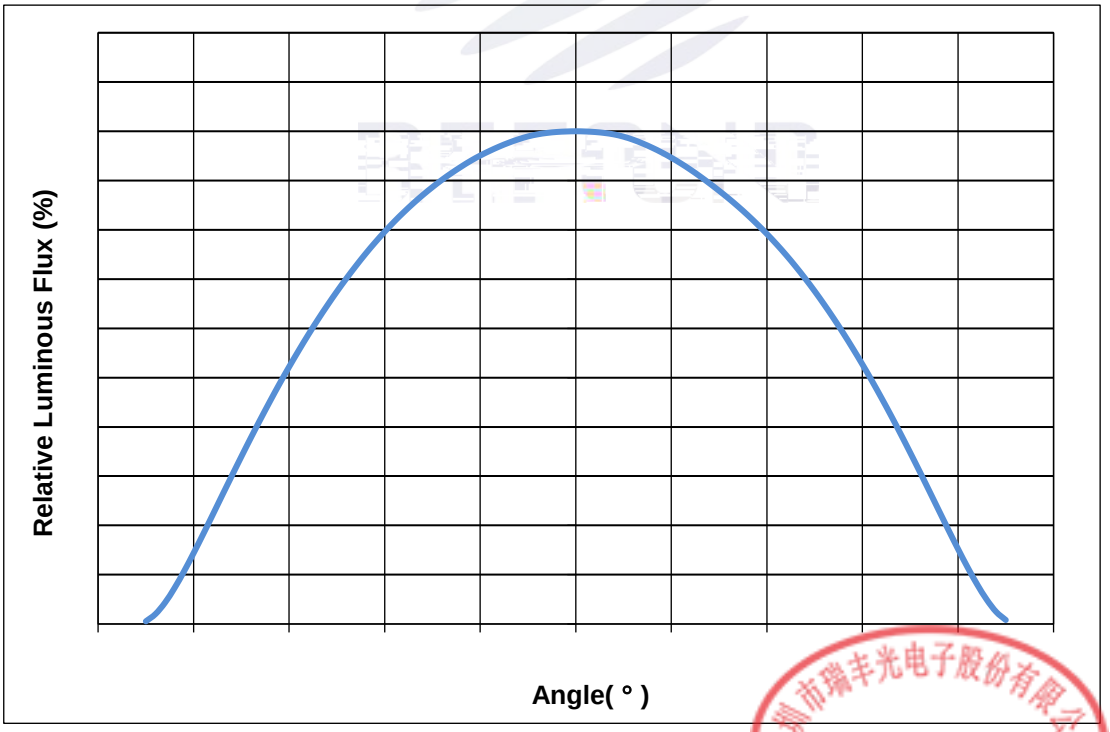

Fig. 1-11 Radiation Diagram

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Fig. 1-12 Dominant Wavelength Shift Vs Junction Temperature

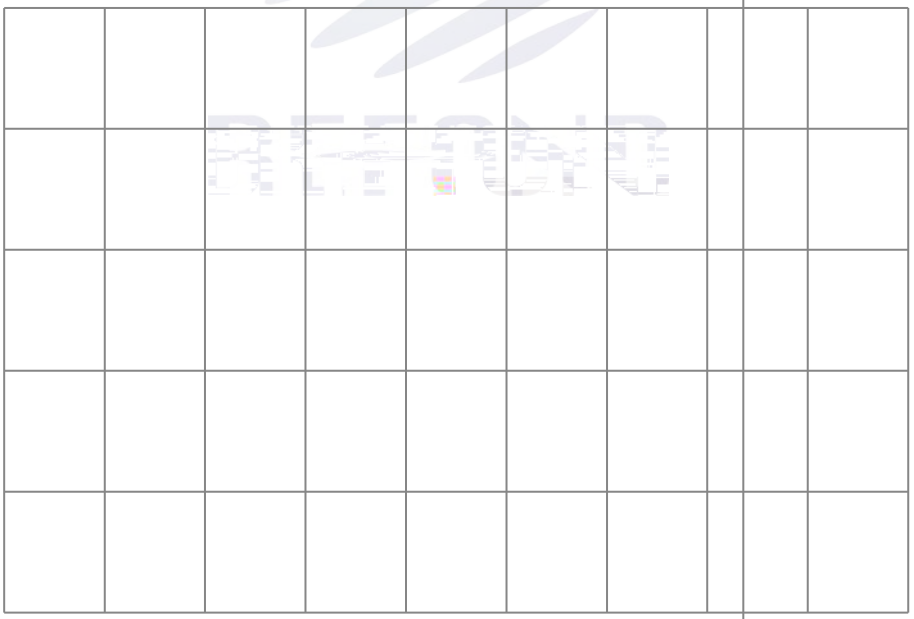

Fig. 1-13 Spectrum Distribution

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2.4Reliability Test Items And Conditions

Table 2-3 Reliability Test Items And Conditions

Test Items	Ref.Standard	Test Condition	Time	Quantity	Ac/Re /
Reflow	JESD22-B106	Temp:260 max T=10 sec	2times	20pcs.	0/1
MSL2 2	JESD22-A113	85 / 60%R_H	168 hrs.	20pcs.	0/1
Thermal Shock	JEITAED-4701 300307	-40 15min 10s 125 15min	1000 cycle	20pcs.	0/1
Life Test	JESD22-A108	Ta=105 IF=350mA	1000hrs.	20pcs.	0/1
High Temperature High Humidity Life Test	JESD22-A101	85 / 85%R_H IF=350mA	1000hrs.	20pcs.	0/1

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2.5 Criteria For Judging Damage

Table 2-4Criteria For Judging Damage

Test Items	Symbol

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3 SMT Reflow Soldering Instructions SMT

3.1SMT Reflow Soldering Instructions SMT

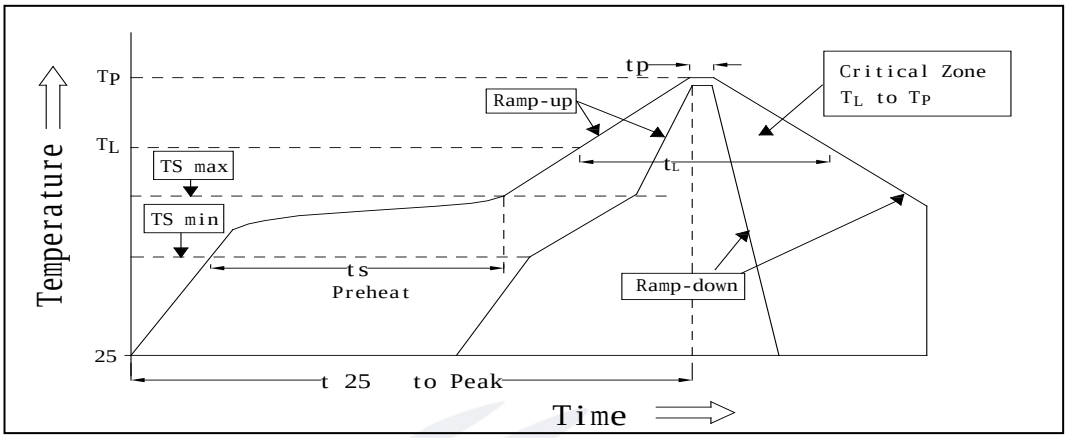

Fig.3-1SMT Reflow Soldering Instructions SMT

Table 3-1Reflow parameters

Average temperature rise speed Tsmax T_P	3 °C/ Max 3 °C/ s
Preheating: minimum temperature (Tsmin)	150 °C
Preheating: Max temperature (Tsmax)	200 °C
Preheating: Time Tsmin Tsmax	60 - 120 60s-120s
Time limited to maintain high temperature: the temperature (T_L)	217 °C
Time limited to maintain high temperature: The Time (t_L)	60 Max 60s
Peak /Classification of temperature: / (T_P)	260 °C
Time limit classification of peak temperature time t_p	10 Max 10s
(T_P) 5 °C Hold time within 5 °C with the actual peak temperature (TP)	30 Max 30s
Cooling speed	6 °C/ Max 6 °C/ s
25 °C Needed time from 25 °C to Tp	8 Max 8 minutes

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Notes

(1)Reflow soldering should not be done more than twice. If more than 24 hours between the two solderings ,LED will be damaged. 24 LED

(2)When soldering , do not put stress on the LEDs during heating.

3.1.1 Repairing

Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable,a double-head soldering iron should be used (as below figure). It should be confirmed in advance whether the characteristics of LEDs will or not be damaged by repairing.

LED LED

3.1.2 Cautions

(1) The encapsulated material of the LEDs is silicone. Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be impacted on the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when use the picking up nozzle, the pressure on the silicone resin should be proper. LED LED

(2) Components should not be mounted on warped (non coplanar) portion of PCB. After soldering, do not warp the circuit board.LED PCB

(3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering. Do not rapidly cool device after soldering.

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4. Handling Precautions

4.1 Handling Precautions

(1) LED operating environment and sulfur element composition cannot be over 100PPM in the LED mating usage material. This is provided for informational purposes only and is not a warranty or endorsement.LED

LED 100PPM.

(2) In order to prevent ex-ternal material from getting into the inside of LED, which may cause the malfunction of LED, the single content of Bromine element is required to be less than 900PPM,the single content of Chlorine elementis required to be less than 900PPM,the total content of Bromine element and Chlorine element in the external materials of the application products is required to be less than 1500PPM. This is provided for informational purposes only and is not a warranty or endorsement. LED LED

900PPM 900PPM

1500PPM.

(3) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues. Refond advises against the use of any chemicals or materials that have been found or are suspected to have an adverse affect on device performance or reliability. To verify compatibility, Refond recommends that all chemicals and materials be tested in the specific application and environment for which they are intended to be used. Attaching LEDs, do not use adhesives that outgas organic vapor. LED

LED LED

LED

(4) Handle the component along the side surface by using forceps or appropriate tools; Do not directly touch or Handle the silicone lens surface, it may damage the internal circuitry.

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Table 4-1 Storage

Conditions		Temperature	Humidity	Time
Storage	Before Opening Aluminum Bag	≤30	≤75%	Within 1 Year From Date
	After Opening Aluminum Bag 24 Ä Reaon 4501 žÄ	≤30	≤60%	Recommended for use within 24 hours 24

Baking 2424

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